

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Masaki SASAKI	01/07/2008
Kenji KATO	01/07/2008
Masao ARIMA	01/07/2008
RECEIVING PARTY DATA	
Name:	TAIYO INK MANUFACTURING COMPANY, LIMITED
Street Address:	2-7-1, Hazawa
City:	Nerima-ku, Tokyo
State/Country:	JAPAN
Postal Code:	176-8508
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12013028
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ATTORNEY DOCKET NUMBER:	320647US40CONT
NAME OF SUBMITTER:	Mona C. Hendrick
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OP \$40.00 12013028

PATENT

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REEL: 020358 FRAME: 0185

ASSIGNMENT

05-00020/USO
(06S0871P1)

In consideration of value received, I, having a mailing address at
c/o TAIYO INK MFG. CO., LTD., Ranzan Facility, 388, Okura, Ranzan-machi,
Hiki-gun, Saitama 355-0222 Japan, and a residence as stated below next to my
name, the sole inventor (if only one name is listed below) or a joint inventor (if
plural inventors are listed below) of an invention described in an application for
United States patent entitled:

SILVER PASTE COMPOSITION, METHOD OF FORMING CONDUCTIVE
PATTERN BY USING THE SAME, AND THE CONDUCTIVE PATTERN FORMED

said application having been filed on January 11, 2008
and assigned Application No. 12/013,028 ;
sell and assign to
TAIYO INK MFG. CO., LTD.
a corporation of Japan, having a business address at
2-7-1, Hazawa, Nerima-ku, Tokyo 176-8508, Japan

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire
right, title and interest in and to said invention as disclosed, shown and described
in said application for United States patent : (check one)

☒ [X] executed concurrently herewith;
☐ [] executed separately herefrom;

and in and to all applications for patent and patents for said invention including all
divisions, reissues, continuations, substitutions and extensions thereof and all
rights arising under or pursuant to any and all international agreements, treaties
or laws relating to the protection of industrial property, including rights of priority,
resulting from the filing of any of said applications; and I authorize and request
any official whose duty is to issue patents, to issue any patent on said invention or
resulting therefrom to said Assignee, and I agree that on request and without
further consideration, but at the expense of said Assignee, I will communicate to
said Assignee or its representatives all facts known to me respecting said invention
and testify in any legal proceeding, sign all lawful papers, execute all divisional,
continuing, reissue or other applications, make all rightful oaths and declarations,
and generally do everything possible to aid said Assignee to obtain and enforce
proper patent protection for said invention in all countries.

I hereby grant the following law firm the power to insert on this Assignment any
further identification which may be necessary or desirable in order to comply with
the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Oblon, Spivak, McClelland, Maier & Neustadt, P.C., 1940 Duke Street, Alexandria,
VA 22314

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05-00020/US0
(06S0871P1)

Inventor: (Signature)

Date

Residence

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